# **GL4800**

#### Features

- 1. Thin type (Thickness:1.5mm)
- 2. Beam angle ( $\Delta \theta$ :TYP. $\pm 30^{\circ}$ )
- 3. Radiant flux
  - $(\Phi_e:MIN. 0.7mW \text{ at } I_F=20mA)$
- 4. Epoxy resin package

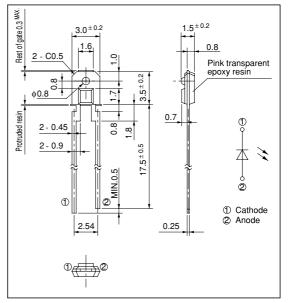
#### Applications

- 1. Floppy disk drives
- 2. Optoelectronic switches

# Thin Type Infrared Emitting Diode

Outline Dimensions

(Unit: mm)



$\begin{array}{c} \textbf{Absolute maximum fattings} & (1_a-23 \text{ C}) \end{array}$						
Parameter	Symbol	Rating	Unit			
Power dissipation	Р	75	mW			
Forward current	I <sub>F</sub>	50	mA			
*1 Peak forward current	I <sub>FM</sub>	1	Α			
Reverse voltage	V <sub>R</sub>	6	V			
Operating temperature	T <sub>opr</sub>	-25 to +85	°C			
Storage temperature	T <sub>stg</sub>	-40 to +85	°C			
*2 Soldering temperature	T <sub>sol</sub>	260	°C			

#### ■ Absolute Maximum Ratings $(T - 25^{\circ}C)$

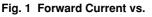
\*1 Pulse width≤100µs, Duty ratio=0.01

\*2 For 3s at the position of 1.8mm from the surface of resin edge

### Electro-optical Characteristics

Electro-optical Characteristics						$T_a=25^{\circ}C)$
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =20mA	-	1.2	1.4	V
Peak forward voltage	V <sub>FM</sub>	$I_{FM}=0.5A$	-	3.0	4.0	V
Reverse current	IR	V <sub>R</sub> =3V	-	-	10	μΑ
Terminal capacitance	Ct	V <sub>R</sub> =0, f=1MHz	-	70	-	pF
Frequency response	f <sub>c</sub>	-	-	300	-	kHz
Radiant flux	$\Phi_{e}$	I <sub>F</sub> =20mA	0.7	1.6	3.0	mW
Peak emission wavelength	λ <sub>p</sub>	I <sub>F</sub> =5mA	-	950	-	nm
Half intensity wavelength	Δλ	I <sub>F</sub> =5mA	-	45	-	nm

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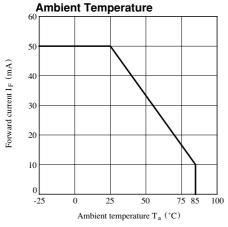


Fig. 3 Spectral Distribution

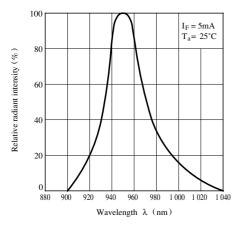


Fig. 5 Forward Current vs. Forward Voltage

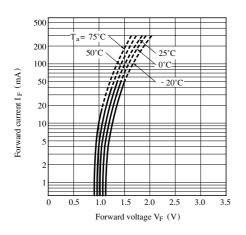


Fig. 2 Peak Forward Current vs. Duty Ratio

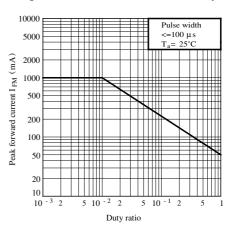


Fig. 4 Peak Emission Wavelength vs. Ambient Temperature

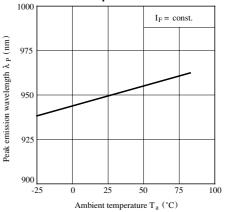


Fig. 6 Relative Radiant Flux vs. Ambient Temperature

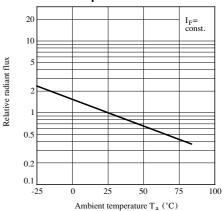
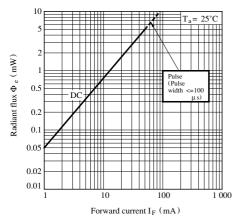
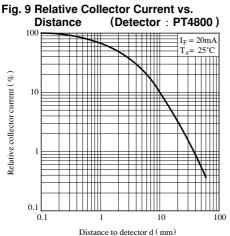
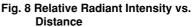


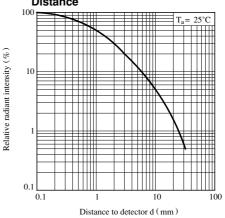
Fig. 7 Radiant Flux vs. Forward Current



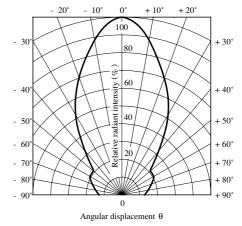


• Please refer to the chapter "Precautions for Use."





**Fig.10 Radiation Diagram**  $(T_a = 25^{\circ}C)$ 



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